

Rittal – The System.

Faster – better – everywhere.



SK 3311.260

Liquid Cooling Package

State: 23/5/2026 (Source: rittal.com/in-en)

ENCLOSURES

POWER DISTRIBUTION

CLIMATE CONTROL

IT INFRASTRUCTURE

SOFTWARE & SERVICES

FRIEDHELM LOH GROUP



SK 3311.260 - Liquid Cooling Package LCP Rack CW, LCP Rack CWG

Cooling via high-performance compact impellers. The LCP draws in the air at the sides at the rear of the server enclosures and blows the cooled air back into the front part of the server enclosure at the sides.

Features

| | |
|--------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Model No. | SK 3311.260 |
| Benefits | <p>Maximum energy efficiency due to EC fan technology and IT-based control</p> <p>Minimal pressure loss at the air end, which in turn minimises the power consumption of the fans</p> <p>Control of the server inlet temperature</p> <p>With redundant temperature sensor integrated at the air end as standard</p> <p>Optimum adaptability due to dynamic, continuous control of the cold water volume flow</p> <p>By using high water inlet temperatures, the proportion of indirect free cooling is increased, which in turn reduces operating costs</p> <p>Targeted cooling output due to modular fan units</p> <p>Fan modules configurable as n+1 redundancy</p> <p>Standard 3-phase connection for electrical redundancy</p> <p>The separation of cooling and enclosure prevents the ingress of water into the server enclosure</p> <p>A footprint of max. 0.36 m² for all cooling services</p> <p>Improved heat recovery, thanks to high water return temperatures when using LCP CW glycol variants, for example in combination with a heat pump</p> <p>Optimum access for maintenance and servicing from the front and rear</p> <p>Tool-free replacement of the fan modules</p> |
| Function principle | <p>The LCP draws in the air at the sides at the rear of the server enclosures, cools it using high-performance compact impellers, and blows the cooled air back into the front part of the server enclosure at the sides</p> |
| Material | Sheet steel, spray-finished |

Features

| | |
|--------------------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Colour | RAL 7035 |
| Options | Fully integrated fire detection and extinguisher system Automatic server enclosure door opening Direct connection of additional CMC III sensors is supported Racks 2200 mm high |
| Design | Rack cooling |
| Monitoring | Monitoring of all system-relevant parameters such as server air intake temperature, server waste air temperature, water inlet/return temperature, water flow, cooling output, fan speed, leakage Direct connection of the unit via SNMP over Ethernet Integration into RiZone |
| Total cooling output/Number of fan modules | 40 kW/4 45 kW/5 55 kW/6 |
| Total cooling output | 40 kW With one additional fan module, total cooling output increases to 45 kW, with two to 55 kW. A maximum of two additional fans can be installed. 45 kW 55 kW |
| Air throughput (unimpeded air flow) | At 50 Hz: 8,000 m ³ /h At 60 Hz: 8,000 m ³ /h |
| Number of fan modules in supplied state | 4 |
| Dimensions | Width: 300 mm Height: 2,000 mm Depth: 1,200 mm |
| To fit enclosure type | TS IT |
| Installation in bayed enclosure suite | Flush |
| Rated operating voltage | 230 V, 1~, 50 Hz/60 Hz 400 V, 3~, 50 Hz/60 Hz |
| Max. cooling output | 55 kW |
| Type of electrical connection | Connector |
| Duty cycle | 100 % |

Features

| | |
|---------------------------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| EC fan | Yes |
| Fans may be exchanged with the system operational | Yes |
| Temperature control | Linear fan control Two-way control valve |
| Water connections | DN 40 (G 1½" external thread) |
| Water inlet temperature | 15 °C |
| Protection category to IEC 60 529 | IP 20 |
| Options | Fully integrated fire detection and extinguisher system Automatic server enclosure door opening Direct connection of additional CMC III sensors is supported Racks 2200 mm high |
| Packs of | 1 pc(s). |
| Net weight | 210 kg |
| Gross weight | 235 kg |
| Customs tariff number | 84158200 |
| ETIM 9 | EC002515 |
| ETIM 8 | EC002515 |
| ECLASS 8.0 | 27180712 |
| Product description | SK LCP Rack CW, Air/water heat exchanger for rack cooling, Mounted on the side of the rack, flush, Cooling of one up to maximum two racks, Support of IT-compatible, "front-to-back" air routing, |

Approvals

| | |
|--------------|---------------------------|
| Explanations | Declaration of conformity |
|--------------|---------------------------|

Tender text

TopTherm LCP Rack CW, 3311.260 WHD(mm) 300x2000x1200

TopTherm LCP RACK CW:

The design of the unit is optimised for use in data centres. The integrated air/water heat exchanger guarantees a cooling output of up to 60 kW, combined with standard server enclosure dimensions, the lowest possible weight and comprehensive possibilities for monitoring.

The air/water heat exchanger is mounted on the side of the rack.

LCP Rack CW offers enclosure-based cooling separate from the room air and is thus also able to reduce the noise level.

The unit is capable of providing cooling for either one or two server racks.

The hot server air is drawn off to the rear of the server rack. After cooling, it is expelled left and right in front of the 482.6 mm (19") level over the whole enclosure height and is thus made available to the IT equipment once more.

The use of four integrated EC fan modules (cooling output up to 40 kW) achieves maximum efficiency and minimises the electrical energy consumption.

The unit is prepared for the incorporation of a maximum of six EC fan modules (cooling output up to 60 kW). For this reason it is possible to retrofit two additional fan modules up to full configuration and achieving the optimum cooling output.

This safeguards the value of an investment where the full cooling output is not yet required at the time of initial operation.

The flow characteristics of the heat exchanger have been optimised for the minimum possible pressure loss on the air side. This in turn minimises the energy consumption of the fans.

The high-performance heat exchanger guarantees maximum cooling output even at high water inlet temperatures, enabling the proportion of operation in combination with indirect free cooling to be maximised and

operating costs reduced accordingly.

The air/water heat exchanger and server rack remain separate from each other. This eliminates the risk of water penetrating into the server rack and improves the ease of installation and service.

Condensate and leakage management is integrated. The water connection can be realised optionally to the top or bottom by way of an accessory kit